

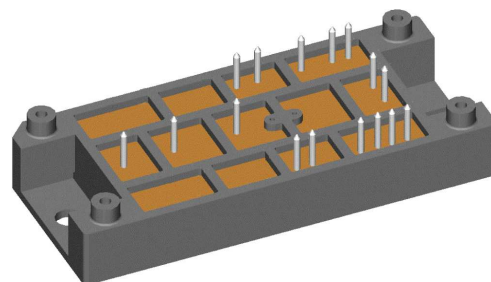
## Standard Rectifier Module

| 3~ Rectifier               | Brake Chopper                 |
|----------------------------|-------------------------------|
| $V_{RRM} = 1600 \text{ V}$ | $V_{CES} = 1200 \text{ V}$    |
| $I_{DAV} = 180 \text{ A}$  | $I_{C25} = 180 \text{ A}$     |
| $I_{FSM} = 1100 \text{ A}$ | $V_{CE(sat)} = 1.7 \text{ V}$ |

3~ Rectifier Bridge + Brake Unit + NTC

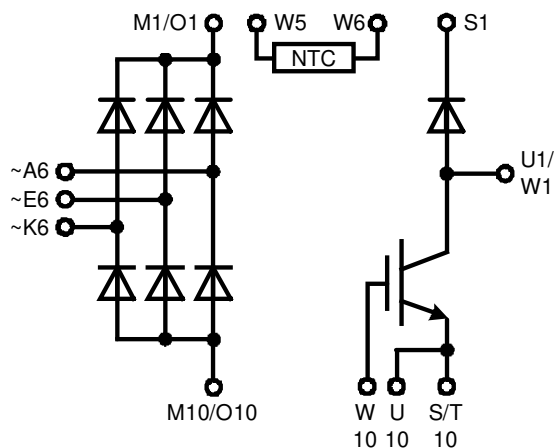
Part number

**VUB120-16NOXT**



Backside: isolated

 E72873



### Features / Advantages:

- Package with DCB ceramic base plate
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current
- NTC
- X2PT - 2nd generation Xtreme light Punch Through
- Rugged X2PT design results in:
  - short circuit rated for 10  $\mu\text{sec}$ .
  - very low gate charge
  - low EMI
  - square RBSOA @ 2x  $I_c$
- Thin wafer technology combined with X2PT design results in a competitive low  $V_{CE(sat)}$  and low thermal resistance

### Applications:

- 3~ Rectifier with brake unit for drive inverters

### Package: V2-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

### Disclaimer Notice

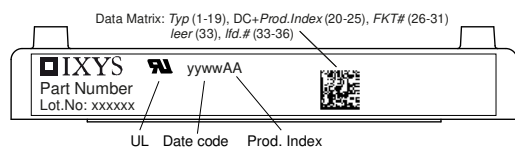
Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).

| Rectifier  |                                              |                                           |                                                     | Ratings                        |      |      |                   |
|------------|----------------------------------------------|-------------------------------------------|-----------------------------------------------------|--------------------------------|------|------|-------------------|
| Symbol     | Definition                                   | Conditions                                |                                                     | min.                           | typ. | max. | Unit              |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^{\circ}\text{C}$             |                                                     |                                |      | 1700 | V                 |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     | $T_{VJ} = 25^{\circ}\text{C}$             |                                                     |                                |      | 1600 | V                 |
| $I_R$      | reverse current                              | $V_R = 1600\text{ V}$                     | $T_{VJ} = 25^{\circ}\text{C}$                       |                                |      | 100  | $\mu\text{A}$     |
|            |                                              | $V_R = 1600\text{ V}$                     | $T_{VJ} = 125^{\circ}\text{C}$                      |                                |      | 2    | mA                |
| $V_F$      | forward voltage drop                         | $I_F = 60\text{ A}$                       | $T_{VJ} = 25^{\circ}\text{C}$                       |                                |      | 1.16 | V                 |
|            |                                              | $I_F = 180\text{ A}$                      |                                                     |                                |      | 1.55 | V                 |
|            |                                              | $I_F = 60\text{ A}$                       | $T_{VJ} = 125^{\circ}\text{C}$                      |                                |      | 1.09 | V                 |
|            |                                              | $I_F = 180\text{ A}$                      |                                                     |                                |      | 1.59 | V                 |
| $I_{DAV}$  | bridge output current                        | $T_C = 90^{\circ}\text{C}$<br>rectangular | $T_{VJ} = 150^{\circ}\text{C}$<br>$d = \frac{1}{3}$ |                                |      | 180  | A                 |
| $V_{F0}$   | threshold voltage                            | } for power loss calculation only         |                                                     | $T_{VJ} = 150^{\circ}\text{C}$ |      | 0.81 | V                 |
| $r_F$      | slope resistance                             |                                           |                                                     |                                |      | 4.4  | m $\Omega$        |
| $R_{thJC}$ | thermal resistance junction to case          |                                           |                                                     |                                |      | 0.6  | K/W               |
| $R_{thCH}$ | thermal resistance case to heatsink          |                                           |                                                     |                                | 0.2  |      | K/W               |
| $P_{tot}$  | total power dissipation                      | $T_C = 25^{\circ}\text{C}$                |                                                     |                                |      | 205  | W                 |
| $I_{FSM}$  | max. forward surge current                   | $t = 10\text{ ms; (50 Hz), sine}$         | $T_{VJ} = 45^{\circ}\text{C}$                       |                                |      | 1.10 | kA                |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$        | $V_R = 0\text{ V}$                                  |                                |      | 1.19 | kA                |
|            |                                              | $t = 10\text{ ms; (50 Hz), sine}$         | $T_{VJ} = 150^{\circ}\text{C}$                      |                                |      | 935  | A                 |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$        | $V_R = 0\text{ V}$                                  |                                |      | 1.01 | kA                |
| $I^2t$     | value for fusing                             | $t = 10\text{ ms; (50 Hz), sine}$         | $T_{VJ} = 45^{\circ}\text{C}$                       |                                |      | 6.05 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$        | $V_R = 0\text{ V}$                                  |                                |      | 5.89 | kA <sup>2</sup> s |
|            |                                              | $t = 10\text{ ms; (50 Hz), sine}$         | $T_{VJ} = 150^{\circ}\text{C}$                      |                                |      | 4.37 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$        | $V_R = 0\text{ V}$                                  |                                |      | 4.25 | kA <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 400\text{ V; } f = 1\text{ MHz}$   |                                                     |                                | 37   |      | pF                |



| Brake IGBT + Diode |                                      |                                                                                                                |                                | Ratings |      |          |               |
|--------------------|--------------------------------------|----------------------------------------------------------------------------------------------------------------|--------------------------------|---------|------|----------|---------------|
| Symbol             | Definition                           | Conditions                                                                                                     |                                | min.    | typ. | max.     | Unit          |
| $V_{CES}$          | collector emitter voltage            | $T_{VJ} = 25^{\circ}\text{C}$                                                                                  |                                |         |      | 1200     | V             |
| $V_{GES}$          | max. DC gate voltage                 |                                                                                                                |                                |         |      | $\pm 20$ | V             |
| $V_{GEM}$          | max. transient gate emitter voltage  |                                                                                                                |                                |         |      | $\pm 30$ | V             |
| $I_{C25}$          | collector current                    | $T_C = 25^{\circ}\text{C}$                                                                                     |                                |         |      | 180      | A             |
| $I_{C80}$          |                                      | $T_C = 80^{\circ}\text{C}$                                                                                     |                                |         |      | 140      | A             |
| $P_{tot}$          | total power dissipation              | $T_C = 25^{\circ}\text{C}$                                                                                     |                                |         |      | 500      | W             |
| $V_{CE(sat)}$      | collector emitter saturation voltage | $I_C = 100\text{ A}; V_{GE} = 15\text{ V}$                                                                     | $T_{VJ} = 25^{\circ}\text{C}$  |         | 1.7  | 2.1      | V             |
|                    |                                      |                                                                                                                | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.9  |          | V             |
| $V_{GE(th)}$       | gate emitter threshold voltage       | $I_C = 4\text{ mA}; V_{GE} = V_{CE}$                                                                           | $T_{VJ} = 25^{\circ}\text{C}$  | 6       | 6.8  | 7.5      | V             |
| $I_{CES}$          | collector emitter leakage current    | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$                                                                        | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.1      | mA            |
|                    |                                      |                                                                                                                | $T_{VJ} = 125^{\circ}\text{C}$ |         | 0.1  |          | mA            |
| $I_{GES}$          | gate emitter leakage current         | $V_{GE} = \pm 20\text{ V}$                                                                                     |                                |         |      | 500      | nA            |
| $Q_{G(on)}$        | total gate charge                    | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 100\text{ A}$                                              |                                |         | 340  |          | nC            |
| $t_{d(on)}$        | turn-on delay time                   | inductive load<br>$V_{CE} = 600\text{ V}; I_C = 100\text{ A}$<br>$V_{GE} = \pm 15\text{ V}; R_G = 6.8\ \Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ |         | 230  |          | ns            |
| $t_r$              | current rise time                    |                                                                                                                |                                |         | 70   |          | ns            |
| $t_{d(off)}$       | turn-off delay time                  |                                                                                                                |                                |         | 380  |          | ns            |
| $t_f$              | current fall time                    |                                                                                                                |                                |         | 230  |          | ns            |
| $E_{on}$           | turn-on energy per pulse             |                                                                                                                |                                |         | 12.5 |          | mJ            |
| $E_{off}$          | turn-off energy per pulse            |                                                                                                                |                                |         | 11.5 |          | mJ            |
| <b>RBSOA</b>       | reverse bias safe operating area     | $V_{GE} = \pm 15\text{ V}; R_G = 6.8\ \Omega$                                                                  | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $I_{CM}$           |                                      | $V_{CEK} = 1200\text{ V}$                                                                                      |                                |         |      | 300      | A             |
| <b>SCSOA</b>       | short circuit safe operating area    | $V_{CEK} = 1200\text{ V}$                                                                                      |                                |         |      |          |               |
| $t_{SC}$           | short circuit duration               | $V_{CE} = 720\text{ V}; V_{GE} = \pm 15$                                                                       | $T_{VJ} = 125^{\circ}\text{C}$ |         |      | 10       | $\mu\text{s}$ |
| $I_{SC}$           | short circuit current                | $R_G = 6.8\ \Omega$ ; non-repetitive                                                                           |                                |         | 450  |          | A             |
| $R_{thJC}$         | thermal resistance junction to case  |                                                                                                                |                                |         |      | 0.25     | K/W           |
| $R_{thCH}$         | thermal resistance case to heatsink  |                                                                                                                |                                |         | 0.10 |          | K/W           |
| Brake Diode        |                                      |                                                                                                                |                                |         |      |          |               |
| $V_{RRM}$          | max. repetitive reverse voltage      |                                                                                                                | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 1200     | V             |
| $I_{F25}$          | forward current                      |                                                                                                                | $T_C = 25^{\circ}\text{C}$     |         |      | 48       | A             |
| $I_{F80}$          |                                      |                                                                                                                | $T_C = 80^{\circ}\text{C}$     |         |      | 32       | A             |
| $V_F$              | forward voltage                      | $I_F = 30\text{ A}$                                                                                            | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 2.75     | V             |
|                    |                                      |                                                                                                                | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.60 |          | V             |
| $I_R$              | reverse current                      | $V_R = V_{RRM}$                                                                                                | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.25     | mA            |
|                    |                                      |                                                                                                                | $T_{VJ} = 125^{\circ}\text{C}$ |         |      | 1        | mA            |
| $Q_{rr}$           | reverse recovery charge              | $V_R = 600\text{ V}$<br>$-di_F/dt = 1000\text{ A}/\mu\text{s}$<br>$I_F = 30\text{ A}; V_{GE} = 0\text{ V}$     | $T_{VJ} = 125^{\circ}\text{C}$ |         | 5.2  |          | $\mu\text{C}$ |
| $I_{RM}$           | max. reverse recovery current        |                                                                                                                |                                |         | 50   |          | A             |
| $t_{rr}$           | reverse recovery time                |                                                                                                                |                                |         | 300  |          | ns            |
| $E_{rec}$          | reverse recovery energy              |                                                                                                                |                                |         | 1.9  |          | mJ            |
| $R_{thJC}$         | thermal resistance junction to case  |                                                                                                                |                                |         |      | 0.9      | K/W           |
| $R_{thCH}$         | thermal resistance case to heatsink  |                                                                                                                |                                |         | 0.3  |          | K/W           |

| Package V2-Pack      |                                                              |                                         |      | Ratings |      |      |  |
|----------------------|--------------------------------------------------------------|-----------------------------------------|------|---------|------|------|--|
| Symbol               | Definition                                                   | Conditions                              | min. | typ.    | max. | Unit |  |
| I <sub>RMS</sub>     | RMS current                                                  | per terminal                            |      |         | 100  | A    |  |
| T <sub>VJ</sub>      | virtual junction temperature                                 |                                         | -40  |         | 150  | °C   |  |
| T <sub>op</sub>      | operation temperature                                        |                                         | -40  |         | 125  | °C   |  |
| T <sub>stg</sub>     | storage temperature                                          |                                         | -40  |         | 125  | °C   |  |
| Weight               |                                                              |                                         |      | 76      |      | g    |  |
| M <sub>D</sub>       | mounting torque                                              |                                         | 2    |         | 2.5  | Nm   |  |
| d <sub>Spp/App</sub> | creepage distance on surface   striking distance through air | terminal to terminal                    | 6.0  |         |      | mm   |  |
| d <sub>Spt/Apb</sub> |                                                              | terminal to backside                    | 12.0 |         |      | mm   |  |
| V <sub>ISOL</sub>    | isolation voltage                                            | t = 1 second                            | 3600 |         |      | V    |  |
|                      |                                                              | t = 1 minute                            | 3000 |         |      | V    |  |
|                      |                                                              | 50/60 Hz, RMS; I <sub>ISOL</sub> ≤ 1 mA |      |         |      |      |  |



| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | VUB120-16NOXT   | VUB120-16NOXT      | Box           | 6        | 520468   |

| Similar Part | Package | Voltage class |
|--------------|---------|---------------|
| VUB120-16NOX | V2-Pack | 1600          |

### Temperature Sensor NTC

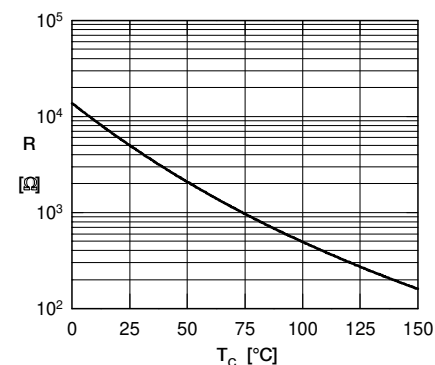
| Symbol      | Definition              | Conditions          | min. | typ. | max. | Unit       |
|-------------|-------------------------|---------------------|------|------|------|------------|
| $R_{25}$    | resistance              | $T_{VJ} = 25^\circ$ | 4.75 | 5    | 5.25 | k $\Omega$ |
| $B_{25/50}$ | temperature coefficient |                     |      | 3375 |      | K          |

### Equivalent Circuits for Simulation

\* on die level

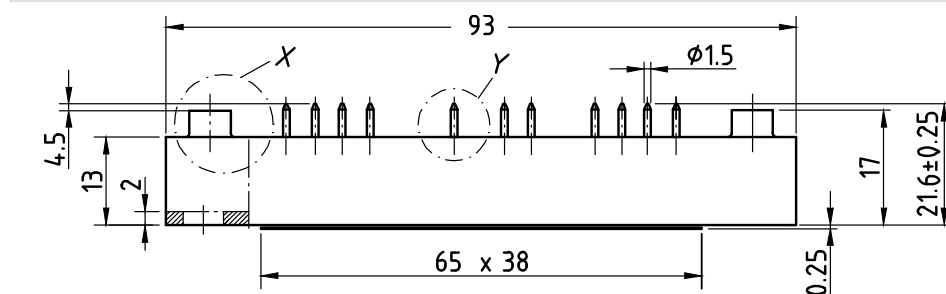
$T_{VJ} = 150^\circ\text{C}$

|       |                    | Rectifier | Brake Diode |            |
|-------|--------------------|-----------|-------------|------------|
| $V_0$ | threshold voltage  | 0.81      | 1.31        | V          |
| $R_0$ | slope resistance * | 3.2       | 8           | m $\Omega$ |

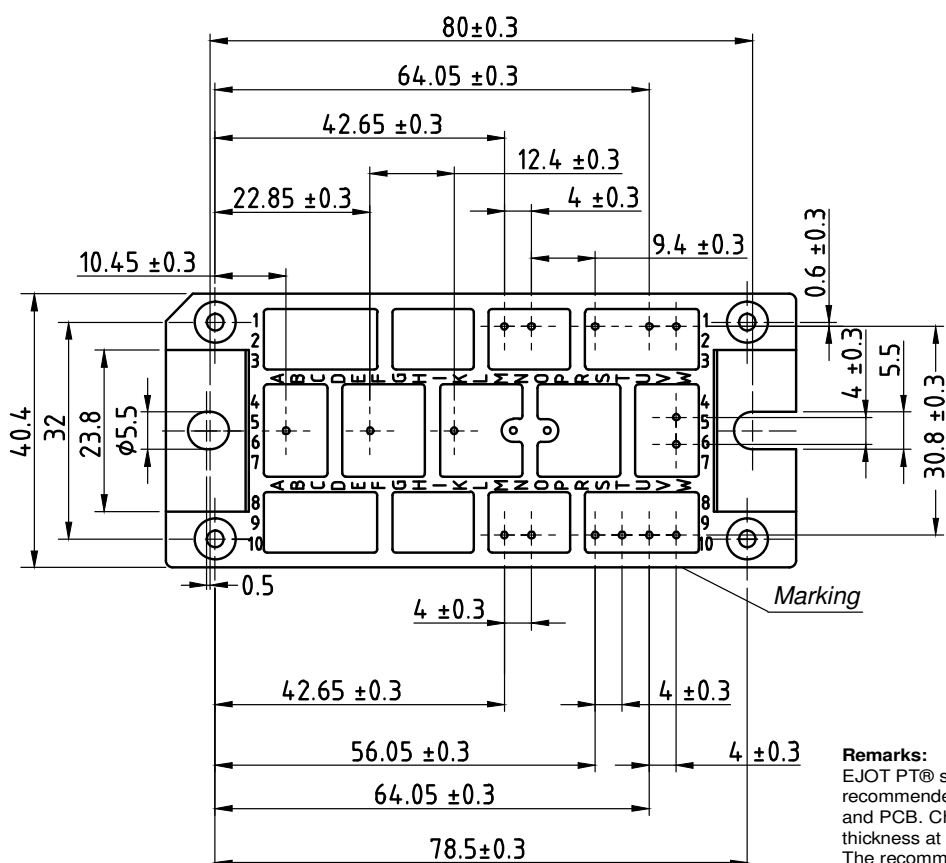
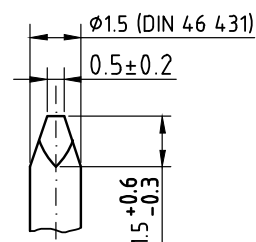


Typ. NTC resistance vs. temperature

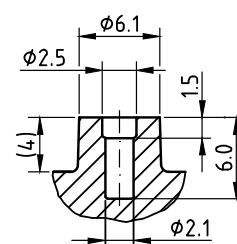
## Outlines V2-Pack



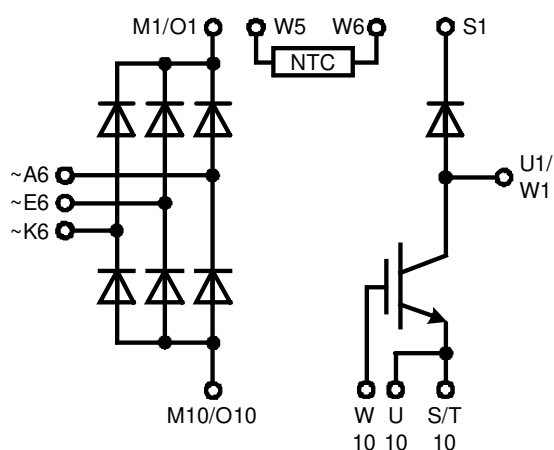
*Detail Y*    *M 5:1*



Detail X M 2:1



**Remarks:**  
EJOT PT® self-tapping screws of the dimension K25 are recommended for the mechanical connection between module and PCB. Choose the right length according to your board thickness at a maximum depth of 6 mm of the module holes. <sup>L</sup>  
The recommended mounting torque is 1.5 Nm.



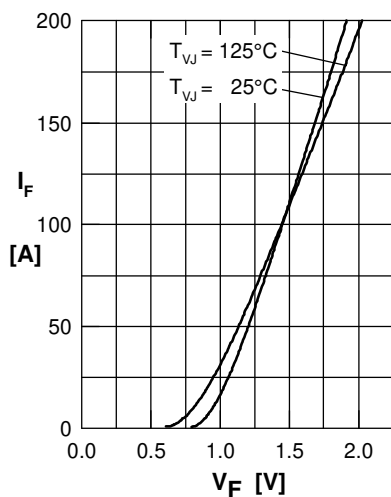
**Rectifier**


Fig. 1 Forward current vs. voltage drop per diode

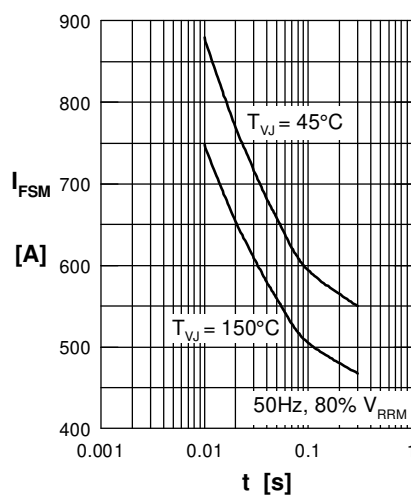


Fig. 2 Surge overload current vs. time per diode

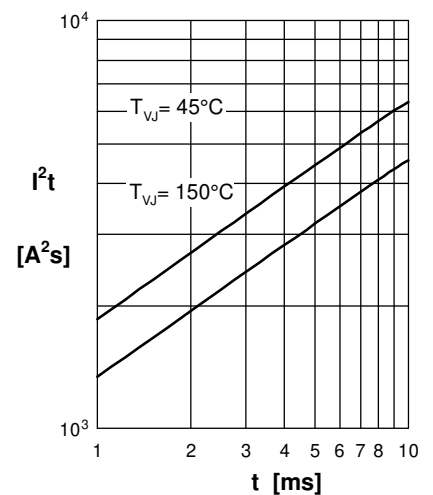


Fig. 3  $I^2t$  vs. time per diode

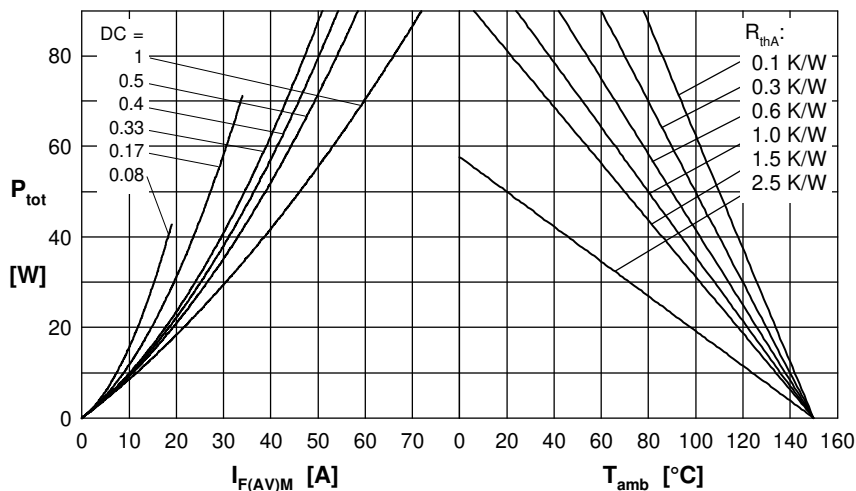


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

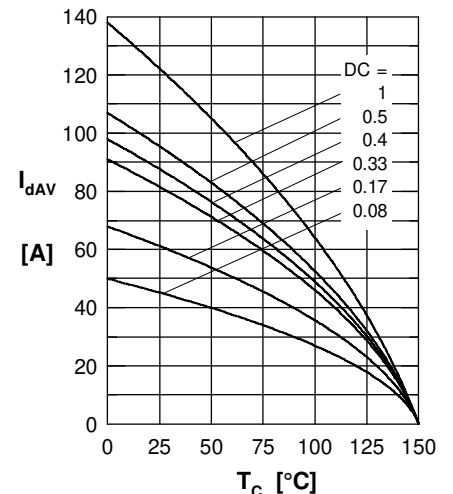


Fig. 5 Max. forward current vs. case temperature per diode

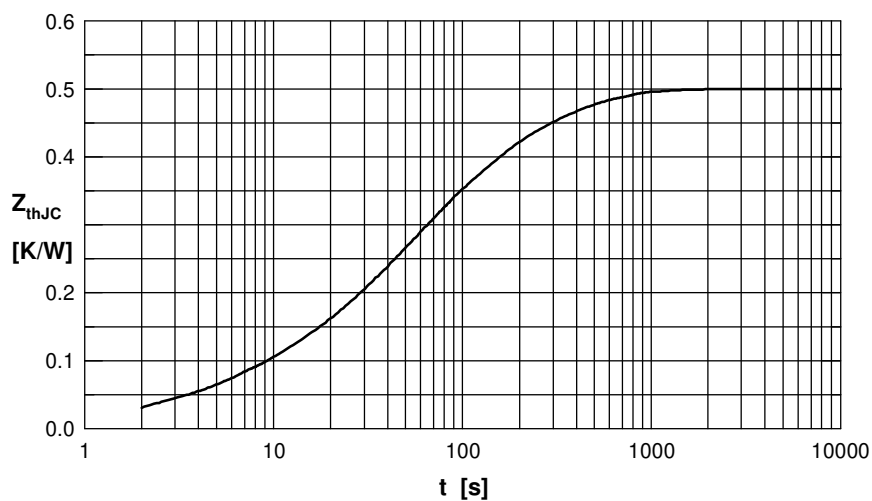


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for  $Z_{thJC}$  calculation:

| i | $R_{th}$ (K/W) | $t_i$ (s) |
|---|----------------|-----------|
| 1 | 0.040          | 0.004     |
| 2 | 0.003          | 0.010     |
| 3 | 0.140          | 0.030     |
| 4 | 0.120          | 0.300     |
| 5 | 0.197          | 0.080     |

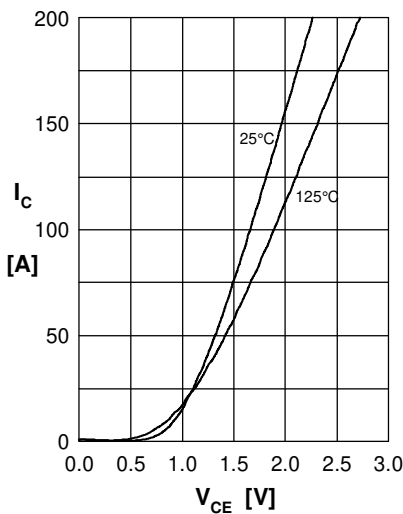
**Brake IGBT + Diode**


Fig.1 Output characteristics IGBT



Fig.2 Typ. output characteristics IGBT

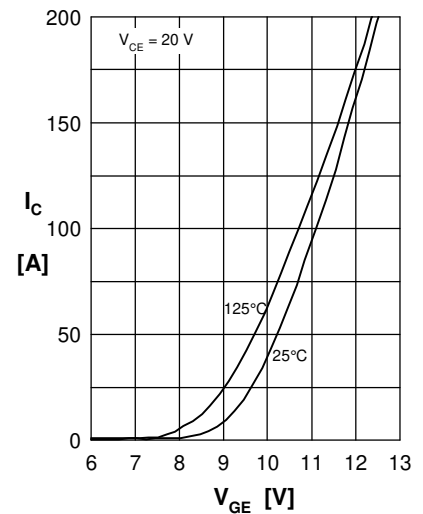


Fig.3 Typ. transfer charact. IGBT

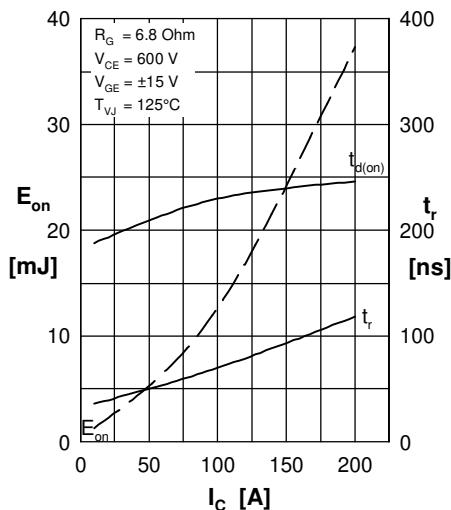


Fig.4 Typ. turn-on energy &amp; switch. times vs. collector current

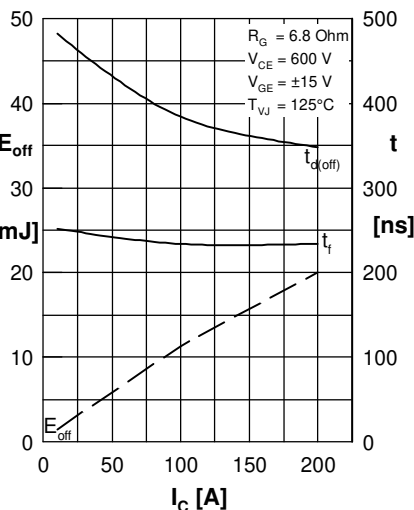


Fig.5 Typ. turn-off energy &amp; switch. times vs. collector current

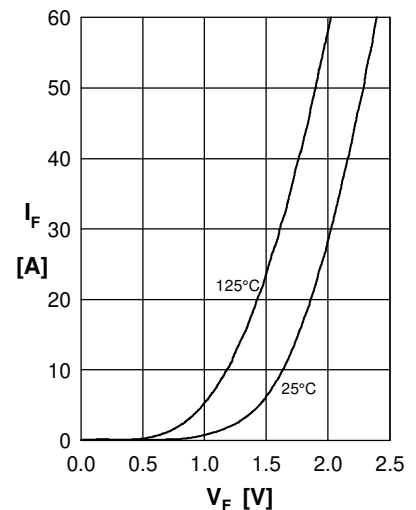


Fig.6 Typ. forward characteristics Diode

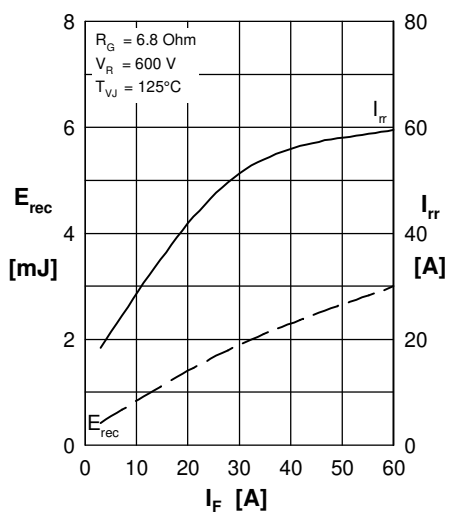


Fig.7 Typ. reverse recovery characteristics Diode

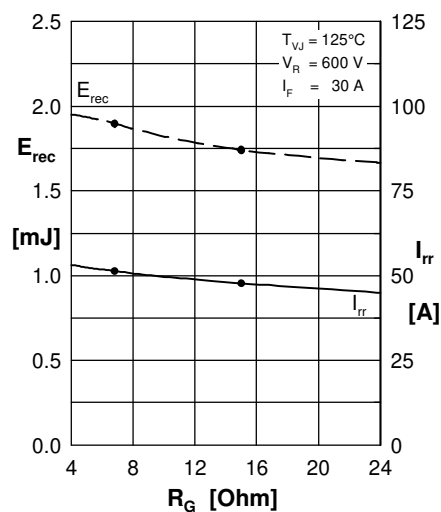


Fig.8 Typ. reverse recovery characteristics Diode

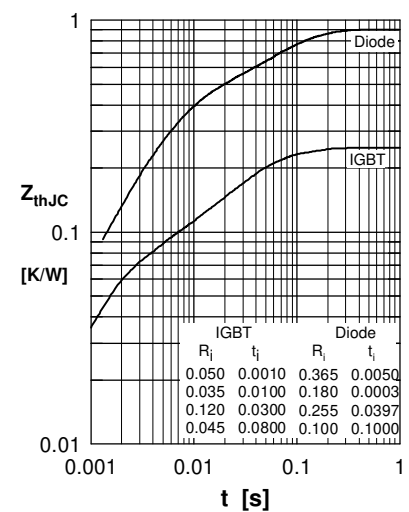


Fig.9 Transient thermal resistance junction to case